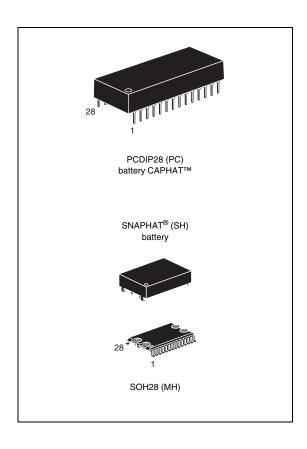


# 256 Kbit (32 Kbit x 8) ZEROPOWER® SRAM

#### **Features**

- Integrated, ultra low power SRAM, power-fail control circuit, and battery
- READ cycle time equals WRITE cycle time
- Automatic power-fail chip deselect and WRITE protection
- WRITE protect voltages: (V<sub>PFD</sub> = Power-fail deselect voltage)
  - M48Z35:  $V_{CC}$  = 4.75 to 5.5 V 4.5 V  $\leq$  V<sub>PFD</sub>  $\leq$  4.75 V
  - M48Z35Y: 4.5 to 5.5 V  $4.2 \text{ V} \le \text{V}_{PFD} \le 4.5 \text{ V}$
- Self-contained battery in the CAPHAT<sup>™</sup> DIP package
- Packaging includes a 28-lead SOIC and SNAPHAT® top (to be ordered separately)
- Pin and function compatible with JEDEC standard 32 K x 8 SRAMs
- SOIC package provides direct connection for a SNAPHAT<sup>®</sup> top which contains the battery
- RoHS compliant
  - Lead-free second level interconnect



Contents M48Z35, M48Z35Y

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**\_\_\_\_\_** 

M48Z35, M48Z35Y Description

### 1 Description

The M48Z35/Y ZEROPOWER<sup>®</sup> RAM is a 32 K x 8, non-volatile static RAM that integrates power-fail deselect circuitry and battery control logic on a single die. The monolithic chip is available in two special packages to provide a highly integrated battery-backed memory solution.

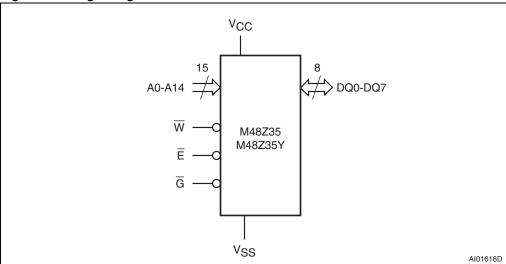
The M48Z35/Y is a non-volatile pin and function equivalent to any JEDEC standard 32 K x 8 SRAM. It also easily fits into many ROM, EPROM, and EEPROM sockets, providing the non-volatility of PROMs without any requirement for special WRITE timing or limitations on the number of WRITEs that can be performed. The 28-pin 600 mil DIP CAPHAT<sup>™</sup> houses the M48Z35/Y silicon with a long life lithium button cell in a single package.

The 28-pin 330 mil SOIC provides sockets with gold plated contacts at both ends for direct connection to a separate SNAPHAT<sup>®</sup> housing containing the battery. The unique design allows the SNAPHAT battery package to be mounted on top of the SOIC package after the completion of the surface mount process. Insertion of the SNAPHAT housing after reflow prevents potential battery damage due to the high temperatures required for device surface-mounting. The SNAPHAT housing is keyed to prevent reverse insertion.

The SOIC and battery packages are shipped separately in plastic anti-static tubes or in tape & reel form.

For the 28-lead SOIC, the battery package (i.e. SNAPHAT) part number is "M4Z28-BR00SH1."





Description M48Z35, M48Z35Y

Table 1. Signal names

| A0-A14          | Address inputs        |
|-----------------|-----------------------|
| DQ0-DQ7         | Data inputs / outputs |
| Ē               | Chip enable input     |
| G               | Output enable input   |
| W               | WRITE enable input    |
| V <sub>CC</sub> | Supply voltage        |
| V <sub>SS</sub> | Ground                |

Figure 2. DIP connections

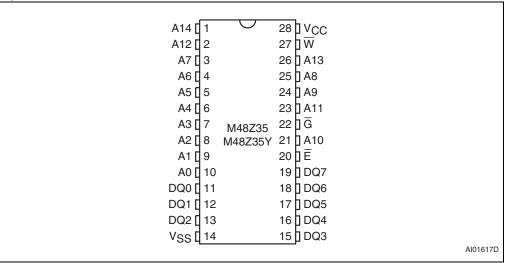
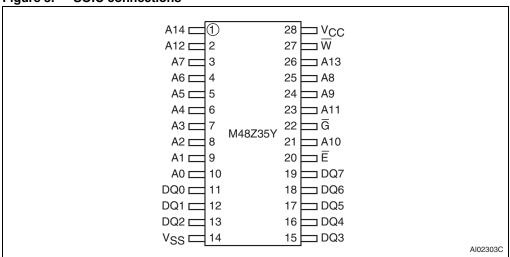
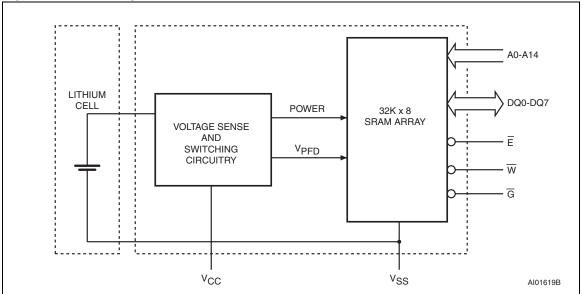


Figure 3. SOIC connections



M48Z35, M48Z35Y Description

Figure 4. Block diagram



Operating modes M48Z35, M48Z35Y

### 2 Operating modes

The M48Z35/Y also has its own power-fail detect circuit. The control circuitry constantly monitors the single 5 V supply for an out of tolerance condition. When  $V_{CC}$  is out of tolerance, the circuit write protects the SRAM, providing a high degree of data security in the midst of unpredictable system operation brought on by low  $V_{CC}$ . As  $V_{CC}$  falls below approximately 3 V, the control circuitry connects the battery which maintains data until valid power returns.

Table 2. Operating modes

| Mode     | v <sub>cc</sub>  | Ē               | G               | W               | DQ0-DQ7          | Power               |
|----------|--|-----------------|-----------------|-----------------|------------------|---------------------|
| Deselect |  | V <sub>IH</sub> | Х               | Х               | High Z           | Standby             |
| WRITE    | 4.75 to 5.5 V<br>or                                      | V <sub>IL</sub> | Х               | V <sub>IL</sub> | D <sub>IN</sub>  | Active              |
| READ     | 4.5 to 5.5 V   | V <sub>IL</sub> | V <sub>IL</sub> | V <sub>IH</sub> | D <sub>OUT</sub> | Active              |
| READ     |  | V <sub>IL</sub> | V <sub>IH</sub> | V <sub>IH</sub> | High Z           | Active              |
| Deselect | V <sub>SO</sub> to V <sub>PFD</sub> (min) <sup>(1)</sup> | Х               | Х               | Х               | High Z           | CMOS standby        |
| Deselect | $\leq V_{SO}^{(1)}$                                      | Χ               | Х               | Х               | High Z           | Battery backup mode |

<sup>1.</sup> See Table 6 on page 12 for details.

Note:  $X = V_{IH}$  or  $V_{IL}$ ;  $V_{SO} = Battery$  backup switchover voltage.

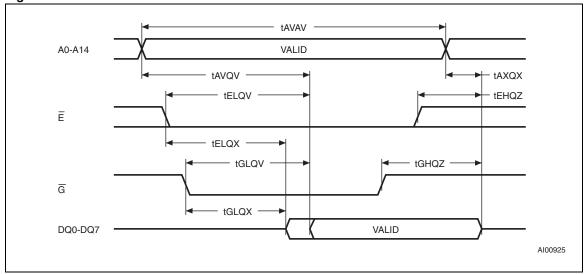
#### 2.1 READ mode

The M48Z35/Y is in the READ mode whenever  $\overline{W}$  (WRITE enable) is high,  $\overline{E}$  (chip enable) is low. The device architecture allows ripple-through access of data from eight of 264,144 locations in the static storage array. Thus, the unique address specified by the 15 address inputs defines which one of the 32,768 bytes of data is to be accessed. Valid data will be available at the data I/O pins within address access time ( $t_{AVQV}$ ) after the last address input signal is stable, providing that the  $\overline{E}$  and  $\overline{G}$  access times are also satisfied. If the  $\overline{E}$  and  $\overline{G}$  access times are not met, valid data will be available after the latter of the chip enable access time ( $t_{ELQV}$ ) or output enable access time ( $t_{GLQV}$ ).

The state of the eight three-state data I/O signals is controlled by  $\overline{E}$  and  $\overline{G}$ . If the outputs are activated before  $t_{AVQV}$ , the data lines will be driven to an indeterminate state until  $t_{AVQV}$ . If the address inputs are changed while  $\overline{E}$  and  $\overline{G}$  remain active, output data will remain valid for output data hold time ( $t_{AXQX}$ ) but will go indeterminate until the next address access.

M48Z35, M48Z35Y Operating modes

Figure 5. READ mode AC waveforms



Note: WRITE enable  $\overline{(W)} = High$ .

Table 3. READ mode AC characteristics

|                                  | Parameter <sup>(1)</sup>                | M482 | Z35/Y |      |  |
|----------------------------------|---|------|-------|------|--|
| Symbol                           |   | -70  |       | Unit |  |
|                                  |   | Min  | Max   |      |  |
| t <sub>AVAV</sub>                | READ cycle time                         | 70   |       | ns   |  |
| t <sub>AVQV</sub> <sup>(2)</sup> | Address valid to output valid           |      | 70    | ns   |  |
| t <sub>ELQV</sub> (2)            | Chip enable low to output valid         |      | 70    | ns   |  |
| t <sub>GLQV</sub> (2)            | Output enable low to output valid       |      | 35    | ns   |  |
| t <sub>ELQX</sub> (3)            | Chip enable low to output transition    | 5    |       | ns   |  |
| t <sub>GLQX</sub> (3)            | Output enable low to output transition  | 5    |       | ns   |  |
| t <sub>EHQZ</sub> (3)            | Chip enable high to output Hi-Z         |      | 25    | ns   |  |
| t <sub>GHQZ</sub> (3)            | Output enable high to output Hi-Z       |      | 25    | ns   |  |
| t <sub>AXQX</sub> <sup>(2)</sup> | Address transition to output transition | 10   |       | ns   |  |

<sup>1.</sup> Valid for ambient operating temperature:  $T_A$  = 0 to 70 °C;  $V_{CC}$  = 4.75 to 5.5 V or 4.5 to 5.5 V (except where noted).

<sup>2.</sup>  $C_L = 100 pF$ .

<sup>3.</sup>  $C_L = 5 pF$ .

Operating modes M48Z35, M48Z35Y

#### 2.2 WRITE mode

The M48Z35/Y is in the WRITE mode whenever  $\overline{W}$  and  $\overline{E}$  are low. The start of a WRITE is referenced from the latter occurring falling edge of  $\overline{W}$  or  $\overline{E}$ . A WRITE is terminated by the earlier rising edge of  $\overline{W}$  or  $\overline{E}$ . The addresses must be held valid throughout the cycle.  $\overline{E}$  or  $\overline{W}$  must return high for a minimum of  $t_{EHAX}$  from chip enable or  $t_{WHAX}$  from WRITE enable prior to the initiation of another READ or WRITE cycle. Data-in must be valid  $t_{DVWH}$  prior to the end of WRITE and remain valid for  $t_{WHDX}$  afterward.  $\overline{G}$  should be kept high during WRITE cycles to avoid bus contention; although, if the output bus has been activated by a low on  $\overline{E}$  and  $\overline{G}$ , a low on  $\overline{W}$  will disable the outputs  $t_{WLOZ}$  after  $\overline{W}$  falls.

Figure 6. WRITE enable controlled, WRITE AC waveforms

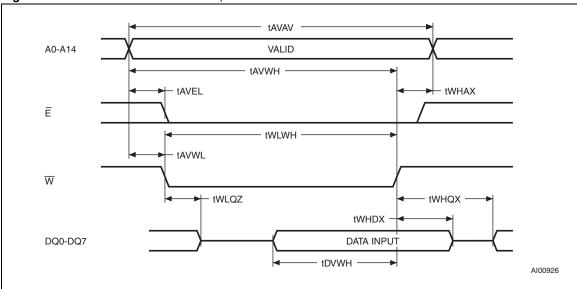
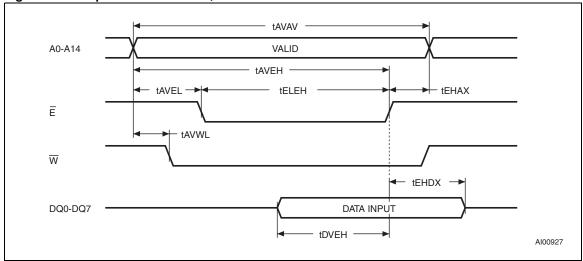


Figure 7. Chip enable controlled, WRITE AC waveforms



M48Z35, M48Z35Y Operating modes

Table 4. WRITE mode AC characteristics

|                                     | Parameter <sup>(1)</sup>                | M482 | Z35/Y |    |
|-------------------------------------|---|------|-------|----|
| Symbol                              |   | _    | -70   |    |
|                                     |   | Min  | Max   |    |
| t <sub>AVAV</sub>                   | WRITE cycle time                        | 70   |       | ns |
| t <sub>AVWL</sub>                   | Address valid to WRITE enable low       | 0    |       | ns |
| t <sub>AVEL</sub>                   | Address valid to chip enable low        | 0    |       | ns |
| t <sub>WLWH</sub>                   | WRITE enable pulse width                | 50   |       | ns |
| t <sub>ELEH</sub>                   | Chip enable low to chip enable high     | 55   |       | ns |
| t <sub>WHAX</sub>                   | WRITE enable high to address transition | 0    |       | ns |
| t <sub>EHAX</sub>                   | Chip enable high to address transition  | 0    |       | ns |
| t <sub>DVWH</sub>                   | Input valid to WRITE enable high        | 30   |       | ns |
| t <sub>DVEH</sub>                   | Input valid to chip enable high         | 30   |       | ns |
| t <sub>WHDX</sub>                   | WRITE enable high to input transition   | 5    |       | ns |
| t <sub>EHDX</sub>                   | Chip enable high to input transition    | 5    |       | ns |
| t <sub>WLQZ</sub> <sup>(2)(3)</sup> | WRITE enable low to output Hi-Z         |      | 25    | ns |
| t <sub>AVWH</sub>                   | Address valid to WRITE enable high      | 60   |       | ns |
| t <sub>AVEH</sub>                   | Address valid to chip enable high       | 60   |       | ns |
| t <sub>WHQX</sub> <sup>(2)(3)</sup> | WRITE enable high to output transition  | 5    |       | ns |

<sup>1.</sup> Valid for ambient operating temperature: T<sub>A</sub> = 0 to 70 °C; V<sub>CC</sub> = 4.75 to 5.5 V or 4.5 to 5.5 V (except where noted).

#### 2.3 Data retention mode

With valid  $V_{CC}$  applied, the M48Z35/Y operates as a conventional BYTEWIDE<sup>TM</sup> static RAM. Should the supply voltage decay, the RAM will automatically power-fail deselect, write protecting itself when  $V_{CC}$  falls within the  $V_{PFD}(max)$ ,  $V_{PFD}(min)$  window. All outputs become high impedance, and all inputs are treated as "don't care."

Note:

A power failure during a WRITE cycle may corrupt data at the currently addressed location, but does not jeopardize the rest of the RAM's content. At voltages below  $V_{PFD}(min)$ , the user can be assured the memory will be in a write protected state, provided the  $V_{CC}$  fall time is not less than  $t_F$  The M48Z35/Y may respond to transient noise spikes on  $V_{CC}$  that reach into the deselect window during the time the device is sampling  $V_{CC}$ . Therefore, decoupling of the power supply lines is recommended.

When  $V_{CC}$  drops below  $V_{SO}$ , the control circuit switches power to the internal battery which preserves data. The internal button cell will maintain data in the M48Z35/Y for an accumulated period of at least 10 years (at 25°C) when  $V_{CC}$  is less than  $V_{SO}$ .

As system power returns and  $V_{CC}$  rises above  $V_{SO}$ , the battery is disconnected, and the power supply is switched to external  $V_{CC}$ . Write protection continues until  $V_{CC}$  reaches  $V_{PFD}$ (min) plus  $t_{REC}$ (min). Normal RAM operation can resume  $t_{REC}$  after  $V_{CC}$  exceeds  $V_{PFD}$ (max).

For more information on battery storage life refer to the application note AN1012.

<sup>2.</sup>  $C_L = 5 pF$  (see Figure 10 on page 15).

<sup>3.</sup> If  $\overline{E}$  goes low simultaneously with  $\overline{W}$  going low, the outputs remain in the high impedance state.

Operating modes M48Z35, M48Z35Y

Figure 8. Power down/up mode AC waveforms

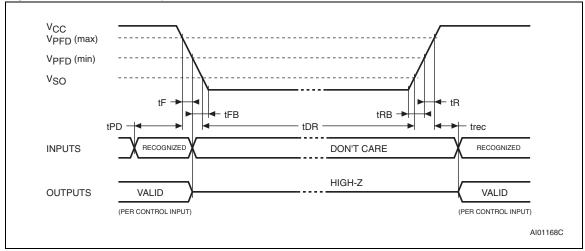


Table 5. Power down/up AC characteristics

| Symbol                        | Parameter <sup>(1)</sup>   | Min | Max | Unit |
|-------------------------------|--|-----|-----|------|
| t <sub>PD</sub>               | E or W at V <sub>IH</sub> before power down                                | 0   |     | μs   |
| t <sub>F</sub> <sup>(2)</sup> | V <sub>PFD</sub> (max) to V <sub>PFD</sub> (min) V <sub>CC</sub> fall time | 300 |     | μs   |
| t <sub>FB</sub> (3)           | V <sub>PFD</sub> (min) to V <sub>SS</sub> V <sub>CC</sub> fall time        | 10  |     | μs   |
| t <sub>R</sub>                | V <sub>PFD</sub> (min) to V <sub>PFD</sub> (max) V <sub>CC</sub> rise time | 10  |     | μs   |
| t <sub>RB</sub>               | V <sub>SS</sub> to V <sub>PFD</sub> (min) V <sub>CC</sub> rise time        | 1   |     | μs   |
| t <sub>rec</sub>              | V <sub>PFD</sub> (max) to inputs recognized                                | 40  | 200 | ms   |

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = 0$  to 70 °C;  $V_{CC} = 4.75$  to 5.5 V or 4.5 to 5.5 V (except where noted).

Table 6. Power down/up trip points DC characteristics

| Symbol                         | Parameter <sup>(1)</sup>          |          | Min | Тур  | Max  | Unit  |
|--------------------------------|-----------------------------------|----------|-----|------|------|-------|
| V                              | Power-fail deselect voltage       | M48Z35   | 4.5 | 4.6  | 4.75 | V     |
| V <sub>PFD</sub>               | M48Z35                            | M48Z35Y  | 4.2 | 4.35 | 4.5  | V     |
| V <sub>SO</sub>                | Battery backup switchover voltage | M48Z35/Y |     | 3.0  |      | V     |
| t <sub>DR</sub> <sup>(2)</sup> | Expected data retention time      |          | 10  |      |      | Years |

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = 0$  to 70 °C;  $V_{CC} = 4.75$  to 5.5V or 4.5 to 5.5V (except where noted).

Note: All voltages referenced to  $V_{SS}$ .

V<sub>PFD</sub> (max) to V<sub>PFD</sub> (min) fall time of less than t<sub>F</sub> may result in deselection/write protection not occurring until 200 μs after V<sub>CC</sub> passes V<sub>PFD</sub> (min).

<sup>3.</sup>  $V_{PFD}$  (min) to  $V_{SS}$  fall time of less than  $t_{FB}$  may cause corruption of RAM data.

<sup>2.</sup> At 25 °C,  $V_{CC} = 0 \text{ V}$ .

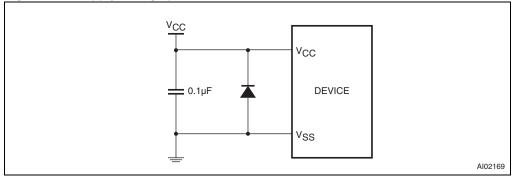
M48Z35, M48Z35Y Operating modes

#### 2.4 V<sub>CC</sub> noise and negative going transients

 $I_{CC}$  transients, including those produced by output switching, can produce voltage fluctuations, resulting in spikes on the  $V_{CC}$  bus. These transients can be reduced if capacitors are used to store energy which stabilizes the  $V_{CC}$  bus. The energy stored in the bypass capacitors will be released as low going spikes are generated or energy will be absorbed when overshoots occur. A ceramic bypass capacitor value of 0.1  $\mu$ F (see *Figure 9*) is recommended in order to provide the needed filtering.

In addition to transients that are caused by normal SRAM operation, power cycling can generate negative voltage spikes on  $V_{CC}$  that drive it to values below  $V_{SS}$  by as much as one volt. These negative spikes can cause data corruption in the SRAM while in battery backup mode. To protect from these voltage spikes, ST recommends connecting a Schottky diode from  $V_{CC}$  to  $V_{SS}$  (cathode connected to  $V_{CC}$ , anode to  $V_{SS}$ ). (Schottky diode 1N5817 is recommended for through hole and MBRS120T3 is recommended for surface mount).

Figure 9. Supply voltage protection



Maximum ratings M48Z35, M48Z35Y

### 3 Maximum ratings

Stressing the device above the rating listed in the absolute maximum ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 7. Absolute maximum ratings

| Symbol                             | Parameter   | Value                    | Unit       |    |
|------------------------------------|---|--------------------------|------------|----|
| $T_A$                              | Ambient operating temperature                             |                          | 0 to 70    | °C |
|                                    |   | SNAPHAT <sup>®</sup> top | -40 to 85  | °C |
| T <sub>STG</sub>                   | Storage temperature (V <sub>CC</sub> off, oscillator off) | CAPHAT <sup>®</sup> DIP  | -40 to 85  | °C |
|                                    |   | SOH28                    | -55 to 125 | °C |
| T <sub>SLD</sub> <sup>(1)(2)</sup> | Lead solder temperature for 10 seconds                    | 260                      | °C         |    |
| V <sub>IO</sub>                    | Input or output voltages                                  | -0.3 to 7.0              | V          |    |
| V <sub>CC</sub>                    | Supply voltage  | -0.3 to 7.0              | V          |    |
| Io                                 | Output current  | 20                       | mA         |    |
| $P_{D}$                            | Power dissipation   |                          | 1          | W  |

For DIP package, soldering temperature of the IC leads is to not exceed 260 °C for 10 seconds. In order to
protect the lithium battery, preheat temperatures must be limited such that the battery temperature does
not exceed +85 °C. Furthermore, the devices shall not be exposed to IR reflow.

Caution: Negative undershoots below –0.3 V are not allowed on any pin while in the battery backup mode.

Caution: Do NOT wave solder SOIC to avoid damaging SNAPHAT® sockets.



<sup>2.</sup> For SOH28 package, lead-free (Pb-free) lead finish: reflow at peak temperature of 260  $^{\circ}$ C (the time above 255  $^{\circ}$ C must not exceed 30 seconds).

### 4 DC and AC parameters

This section summarizes the operating and measurement conditions, as well as the DC and AC characteristics of the device. The parameters in the following DC and AC characteristic tables are derived from tests performed under the measurement conditions listed in *Table 8: Operating and AC measurement conditions*. Designers should check that the operating conditions in their projects match the measurement conditions when using the quoted parameters.

Table 8. Operating and AC measurement conditions

| Parameter                                       | M48Z35      | M48Z35Y    | Unit |
|---|-------------|------------|------|
| Supply voltage (V <sub>CC</sub> )               | 4.75 to 5.5 | 4.5 to 5.5 | V    |
| Ambient operating temperature (T <sub>A</sub> ) | 0 to 70     | 0 to 70    | °C   |
| Load capacitance (C <sub>L</sub> )              | 100         | 100        | pF   |
| Input rise and fall times                       | ≤ 5         | ≤ 5        | ns   |
| Input pulse voltages                            | 0 to 3      | 0 to 3     | V    |
| Input and output timing ref. voltages           | 1.5         | 1.5        | V    |

Note: Output Hi-Z is defined as the point where data is no longer driven.

Figure 10. AC measurement load circuit

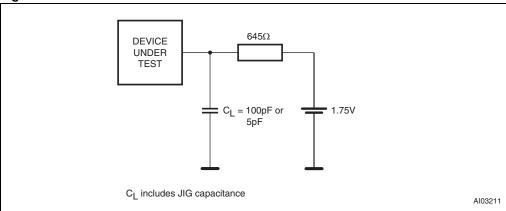


Table 9. Capacitance

| Symbol              | Parameter <sup>(1)(2)</sup> | Min | Max | Unit |
|---------------------|-----------------------------|-----|-----|------|
| C <sub>IN</sub>     | Input capacitance           | -   | 10  | pF   |
| C <sub>IO</sub> (3) | Input / output capacitance  | -   | 10  | pF   |

- 1. Effective capacitance measured with power supply at 5 V. Sampled only, not 100% tested.
- 2. Outputs deselected.
- 3. At 25 °C.

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Table 10. DC characteristics

| Symbol                         | Parameter                     | Test condition <sup>(1)</sup>                                      | Min  | Max                   | Unit |
|--------------------------------|-------------------------------|--|------|-----------------------|------|
| I <sub>LI</sub> <sup>(2)</sup> | Input leakage current         | $0 \text{ V} \leq V_{IN} \leq V_{CC}$                              |      | ±1                    | μΑ   |
| I <sub>LO</sub> <sup>(2)</sup> | Output leakage current        | $0 \text{ V} \leq \text{V}_{\text{OUT}} \leq \text{V}_{\text{CC}}$ |      | ±5                    | μΑ   |
| I <sub>CC</sub>                | Supply current                | Outputs open   |      | 50                    | mA   |
| I <sub>CC1</sub>               | Supply current (standby) TTL  | E = V <sub>IH</sub>  |      | 3                     | mA   |
| I <sub>CC2</sub>               | Supply current (standby) CMOS | $\overline{E} = V_{CC} - 0.2 \text{ V}$                            |      | 3                     | mA   |
| V <sub>IL</sub>                | Input low voltage             |  | -0.3 | 0.8                   | V    |
| V <sub>IH</sub>                | Input high voltage            |  | 2.2  | V <sub>CC</sub> + 0.3 | V    |
| V <sub>OL</sub>                | Output low voltage            | I <sub>OL</sub> = 2.1 mA   |      | 0.4                   | V    |
| V <sub>OH</sub>                | Output high voltage           | I <sub>OH</sub> = −1 mA  | 2.4  |                       | V    |

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = 0$  to 70 °C;  $V_{CC} = 4.75$  to 5.5 V or 4.5 to 5.5 V (except where noted).

<sup>2.</sup> Outputs deselected.

## 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Figure 11. PCDIP28 – 28-pin plastic DIP, battery CAPHAT™, package outline

Note: Drawing is not to scale.

Table 11. PMDIP28 – 28-pin plastic DIP, battery CAPHAT™, pack. mech. data

| Symbol | mm    |       |       | inches |       |       |  |
|--------|-------|-------|-------|--------|-------|-------|--|
|        | Тур   | Min   | Max   | Тур    | Min   | Max   |  |
| Α      |       | 8.89  | 9.65  |        | 0.350 | 0.380 |  |
| A1     |       | 0.38  | 0.76  |        | 0.015 | 0.030 |  |
| A2     |       | 8.38  | 8.89  |        | 0.330 | 0.350 |  |
| В      |       | 0.38  | 0.53  |        | 0.015 | 0.021 |  |
| B1     |       | 1.14  | 1.78  |        | 0.045 | 0.070 |  |
| С      |       | 0.20  | 0.31  |        | 0.008 | 0.012 |  |
| D      |       | 39.37 | 39.88 |        | 1.550 | 1.570 |  |
| E      |       | 17.83 | 18.34 |        | 0.702 | 0.722 |  |
| e1     |       | 2.29  | 2.79  |        | 0.090 | 0.110 |  |
| e3     | 33.02 |       |       | 1.3    |       |       |  |
| eA     |       | 15.24 | 16.00 |        | 0.600 | 0.630 |  |
| L      |       | 3.05  | 3.81  |        | 0.120 | 0.150 |  |
| N      |       | 28    | •     |        | 28    | •     |  |

B P C CP A1 A1 A1 A L SOHA

Figure 12. SOH28 – 28-lead plastic small outline, battery SNAPHAT®, pack. outline

Note: Drawing is not to scale.

Table 12. SOH28 – 28-lead plastic small outline, battery SNAPHAT<sup>®</sup>, pack. mech. data

| Symbol | mm   |       |       | inches |       |       |
|--------|------|-------|-------|--------|-------|-------|
|        | Тур  | Min   | Max   | Тур    | Min   | Max   |
| Α      |      |       | 3.05  |        |       | 0.120 |
| A1     |      | 0.05  | 0.36  |        | 0.002 | 0.014 |
| A2     |      | 2.34  | 2.69  |        | 0.092 | 0.106 |
| В      |      | 0.36  | 0.51  |        | 0.014 | 0.020 |
| С      |      | 0.15  | 0.32  |        | 0.006 | 0.012 |
| D      |      | 17.71 | 18.49 |        | 0.697 | 0.728 |
| E      |      | 8.23  | 8.89  |        | 0.324 | 0.350 |
| е      | 1.27 | _     | -     | 0.050  | -     | -     |
| eB     |      | 3.20  | 3.61  |        | 0.126 | 0.142 |
| Н      |      | 11.51 | 12.70 |        | 0.453 | 0.500 |
| L      |      | 0.41  | 1.27  |        | 0.016 | 0.050 |
| а      |      | 0°    | 8°    |        | 0°    | 8°    |
| N      |      | 28    |       |        | 28    |       |
| СР     |      |       | 0.10  |        |       | 0.004 |

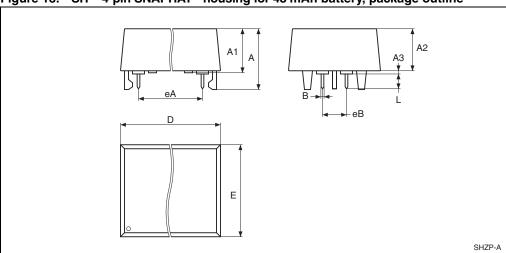


Figure 13. SH – 4-pin SNAPHAT® housing for 48 mAh battery, package outline

Note: Drawing is not to scale.

Table 13. SH – 4-pin SNAPHAT® housing for 48 mAh battery, pack. mech. data

| Symbol | mm  |       |       | inches |       |       |  |
|--------|-----|-------|-------|--------|-------|-------|--|
|        | Тур | Min   | Max   | Тур    | Min   | Max   |  |
| Α      |     |       | 9.78  |        |       | 0.385 |  |
| A1     |     | 6.73  | 7.24  |        | 0.265 | 0.285 |  |
| A2     |     | 6.48  | 6.99  |        | 0.255 | 0.275 |  |
| А3     |     |       | 0.38  |        |       | 0.015 |  |
| В      |     | 0.46  | 0.56  |        | 0.018 | 0.022 |  |
| D      |     | 21.21 | 21.84 |        | 0.835 | 0.860 |  |
| Е      |     | 14.22 | 14.99 |        | 0.560 | 0.590 |  |
| eA     |     | 15.55 | 15.95 |        | 0.612 | 0.628 |  |
| eB     |     | 3.20  | 3.61  |        | 0.126 | 0.142 |  |
| L      |     | 2.03  | 2.29  |        | 0.080 | 0.090 |  |

Figure 14. SH – 4-pin SNAPHAT® housing for 120 mAh battery, package outline

Note: Drawing is not to scale.

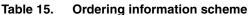
Table 14. SH – 4-pin SNAPHAT® housing for 120 mAh battery, pack. mech. data

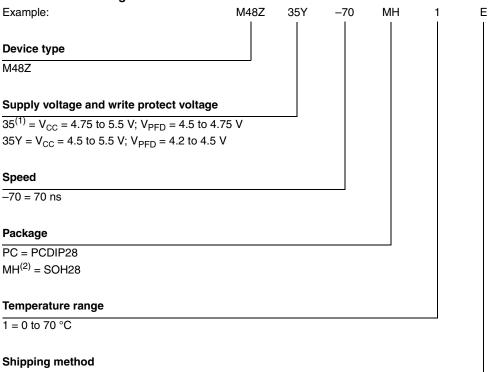
| Symb | mm  |       |       | inches |       |       |
|------|-----|-------|-------|--------|-------|-------|
|      | Тур | Min   | Max   | Тур    | Min   | Max   |
| Α    |     |       | 10.54 |        |       | 0.415 |
| A1   |     | 8.00  | 8.51  |        | 0.315 | 0.335 |
| A2   |     | 7.24  | 8.00  |        | 0.285 | 0.315 |
| A3   |     |       | 0.38  |        |       | 0.015 |
| В    |     | 0.46  | 0.56  |        | 0.018 | 0.022 |
| D    |     | 21.21 | 21.84 |        | 0.835 | 0.860 |
| E    |     | 17.27 | 18.03 |        | 0.680 | 0.710 |
| eA   |     | 15.55 | 15.95 |        | 0.612 | 0.628 |
| eB   |     | 3.20  | 3.61  |        | 0.126 | 0.142 |
| L    |     | 2.03  | 2.29  |        | 0.080 | 0.090 |

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M48Z35, M48Z35Y Part numbering

### 6 Part numbering





For SOH28:

E = Lead-free ECOPACK® package, tubes

F = Lead-free ECOPACK® package, tape & reel

For PCDIP28:

blank = Tubes

- 1. The M48Z35 part is offered with the PCDIP28 (CAPHAT) package only.
- The SOIC package (SOH28) requires the SNAPHAT<sup>®</sup> battery package which is ordered separately under the part number "M4Zxx-BR00SH1" in plastic tubes (see *Table 16*).

#### Caution:

Do not place the SNAPHAT battery package "M4Zxx-BR00SH1" in conductive foam as it will drain the lithium button-cell battery.

For other options, or for more information on any aspect of this device, please contact the ST sales office nearest you.

Table 16. SNAPHAT® battery table

| Part number   | Description                        | Package |
|---------------|------------------------------------|---------|
| M4Z28-BR00SH1 | Lithium battery (48 mAh) SNAPHAT®  | SH      |
| M4Z32-BR00SH1 | Lithium battery (120 mAh) SNAPHAT® | SH      |

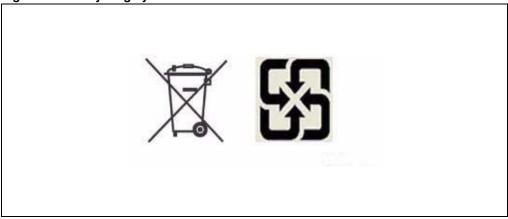
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#### 7 Environmental information

Figure 15. Recycling symbols



This product contains a non-rechargeable lithium (lithium carbon monofluoride chemistry) button cell battery fully encapsulated in the final product.

Recycle or dispose of batteries in accordance with the battery manufacturer's instructions and local/national disposal and recycling regulations.

Please refer to the following web site address for additional information regarding compliance statements and waste recycling.

Go to www.st.com/nvram, then select "Lithium Battery Recycling" from "Related Topics".

M48Z35, M48Z35Y Revision history

# 8 Revision history

Table 17. Document revision history

| Date        | Revision | Changes   |  |
|-------------|----------|---|--|
| Aug-1999    | 1        | First issue   |  |
| 21-Apr-2000 | 1.1      | SH and SH28 packages for 2-pin and 2-socket removed   |  |
| 10-May-2001 | 2        | Reformatted; added temperature information (Table 9, 10, 3, , 5, 6)   |  |
| 29-May-2002 | 2.1      | Modified reflow time and temperature footnotes (Table 7)  |  |
| 02-Apr-2003 | 3        | v2.2 template applied; test condition updated (Table 6)   |  |
| 03-Mar-2004 | 4        | Reformatted; updated with Lead-free information (Table 7, 15)   |  |
| 20-Aug-2004 | 5        | Reformatted; remove references to 'crystal' (cover page)  |  |
| 09-Jun-2005 | 6        | Removal of SNAPHAT <sup>®</sup> , industrial temperature sales types ( <i>Table 3</i> , , $5$ , $6$ , $7$ , $8$ , $10$ , $15$ )                                   |  |
| 02-Nov-2007 | 7        | Reformatted; added lead-free second level interconnect information to cover page and <i>Section 5: Package mechanical data</i> ; updated <i>Table 7</i> , 15, 16. |  |
| 25-Mar-2009 | 8        | Updated Table 7, text in Section 5: Package mechanical data; added Section 7: Environmental information.  |  |
| 19-Aug-2010 | 9        | Updated Section 3, Table 11; reformatted document.  |  |

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